

PRODUCT SPECIFICATION

TFT MODULE

MODEL: LT-043480272-C02R Rev B

CUSTOMER APPROVAL						
SIGNATURE	DATE					

PREPARED	CHECKED	APPROVED



Revision History

Date	Rev.	Description	Note	Page
2019-08-07	Α	New issue		
2019-09-18	В	Update Temperature Range Update White Chromaticity		P3 P4



Contents

1.	Features	3
2.	Mechanical Specifications	3
3.	Absolute Maximum Ratings	3
4.	DC Electrical Characteristics	4
5.	Optical Characteristics	4
6.	Backlight Characteristics	8
7.	Touch Panel Characteristics	8
8.	Interface Pin Description	8
9.	Block Diagram of Display	10
10.	Count Drawing	11
11.	Timing Characteristics	12
12.	Reliability	12
13.	Specification of Quality Assurance	13
14.	Precaution for Using LCD Module	22



1. Features

Item	Standard Value	
Display Type	480(RGB)*272 Dots	
LCD Type	Color TFT, Transmissive	
Screen Size(inch)	4.3	
Viewing Direction	ALL o'clock	
Backlight	White	
Weight	TBD	
Interface	24-bit 8:8:8 RGB	
Other(controller/driver IC)	Sitronix SC7283	

2. Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	105.4(L)*67.1(W)*4.15(T)	mm
Active Area	95.04(L)*53.856 (W)	mm
Dots Pitch	0.198(L)*0.198(W)	mm

3. Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage(Analog)	V _{DDA}	-	3.0	3.6	v
Power Supply Voltage(I/O)	V _{DDI}	-	3.0	3.6	v
Logic Input Voltage	V _{IN}	-	DGND	VDDI	v
Logic Output Voltage	Vo	-	DGND	VDDI	v
Operating Temperature	T _{OP}	-	-20	70	°C
Storage Temperature	T _{ST}	-	-30	80	°C
Humidity	-	Ta≦60℃	-	90	RH

4. DC Electrical Characteristics



4. DC Electrical Characteristics

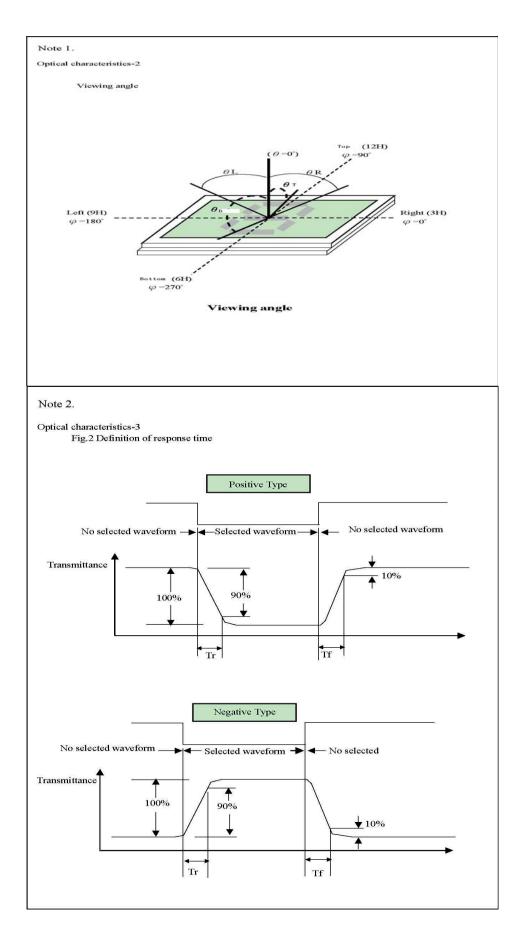
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
System Voltage	V_{DDA}	Operating Voltage	3.0	3.3	3.6	V
Interface Voltage	V _{DDI}	I/O Supply Voltage	3.0	3.3	3.6	V
"H" Input Voltage	V _{IH}	-	0.7VDDI		VDDI	V
"L" Input Voltage	V _{IL}	-	DGND		0.3VDDI	V
"H" Output Voltage	V _{OH}	-	VDDI-0.4		VDDI	V
"L" Output Voltage	V _{OL}	-	DGND		DGND+0.4	V
Supply Current	1	Normal		20		mA
Supply Current	I _{DD}	Stand-by			0.05	mA
TFT gate on voltage	VGH		13	15	16.5	V
TFT gate off voltage	VGL		-7	-10	-11	V
TFT common electrode voltage	Vcom	_		0		V
TFT operation frame rate	Hz	-		60		Hz

5. Optical Characteristics

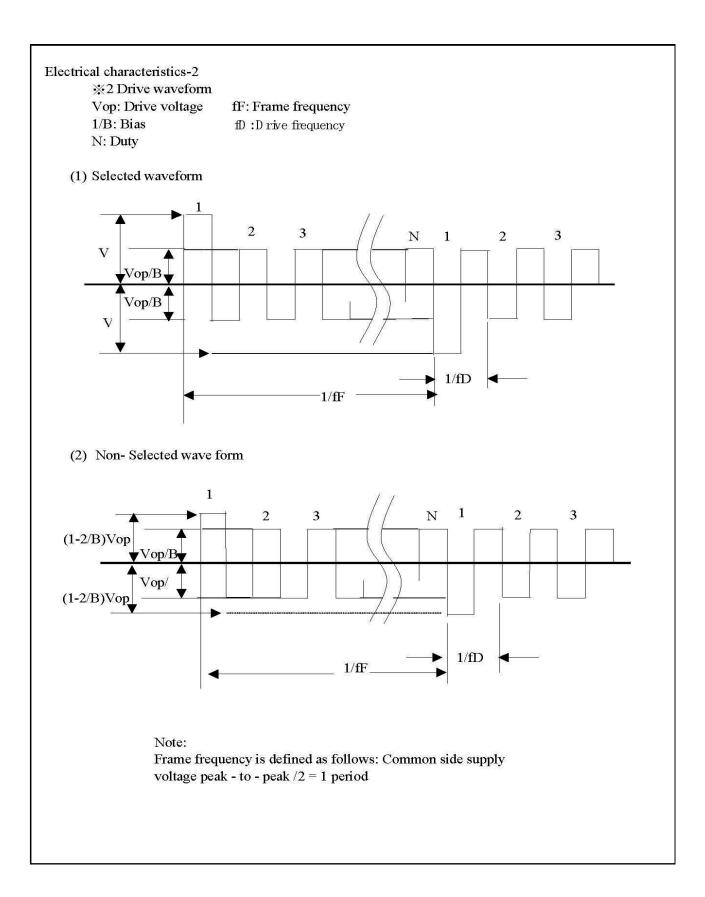
lte	m	Symbol Conditions		Min.	Тур.	Max.	Reference
	Тор	Θy+		70	80		
View Angle	Bottom	Θу-	C <u>></u> 10	70	80		Notes 1 & 2
view Aligie	Left	Θx+	0210	70	80		NOLES I & Z
	Right	Θx-		70	80		
	White	Х			0.319		
	vvnite	Y			0.325		
	Red	Х			0.629	X/Y+0.05	
CIE *1	Reu	Y	TA=25° Θx, ΘY=0°	X/Y-0.05	0.326		Notes 5
CIEI	Green	Х			0.337		notes 5
		Y			0.546		
	Dhua	Х			0.136		
	Blue	Y			0.143		
Uniformity				70			Note 4
Contrast Ratio C		Cr	$\theta Y = 5^{\circ}, \emptyset = 0^{\circ}$	640	800		Note 3
Surface B	rightness	L	$\emptyset = 0^{\circ}$	150	220		Note 3 & 4
NTSC							
Respons		TR+TF	$\emptyset = 0^{\circ}$		30	40	Note 2

*1: This value will be changed while mass product.



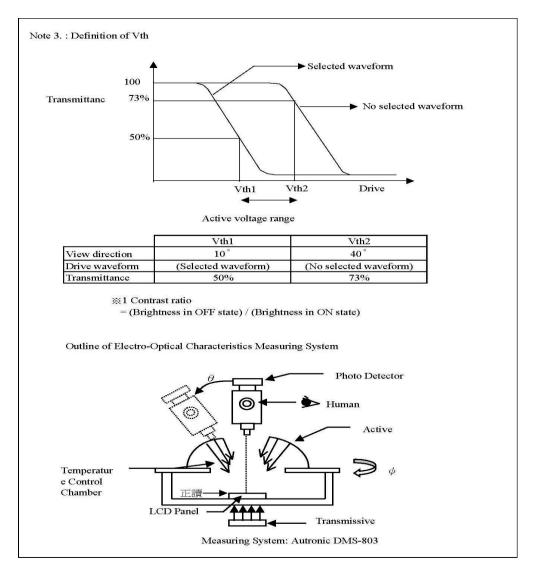






6

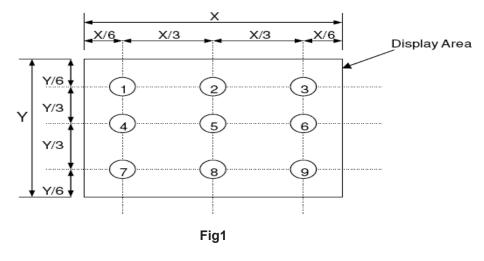




Note 4. Definition of Surface Luminance, Uniformity. (Ref Fig1) Surface Luminance: LV=average (LP1:LP9) Uniformity=Minimal (LP1:LP9)/Maximal (LP1:LP9)*100%

Color Coordinate: The test condition is at IF current of backlight and measured on the surface of LCD module.

Note 5. CIE(x, y) chromaticity is the Center point value. (Ref Fig1)





6. Backlight Characteristics

Item	Item Symbol		Min.	Тур.	Max.	Unit
Forward Voltage(ten LED)	V _F	I _F =18MA	16.2	18.0	20.4	V
Forward Current	I _F					mA
LED Life time (50% initial brightness)	Ta=25\C, IF=15mA			50000H	minimum	
Color	white					

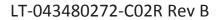
7. Touch Panel Characteristics

RTP

Item	Requirement			
Touch Panel Type	Analog,4 wire			
Touch Structure	G+F			
Surface Hardness	3H(min)			
Hitting Durability	1000,000 Charactors (min)			
Pen Sliding Durability	100,000 Charactors(min)			
Insulation Impedance	20M欧姆(min)			
Linearity(X & Y)	1.5%(max)			
Response Time	10ms(max)			
Terminal Resistance for X & Y axis	X:500-1000欧姆, Y:170-330欧姆			
Operation Force	80g(min)			

8. Interface Pin Description

Pin No.	Symbol	Function
1	LED(-)	Backlight power
2	LED(+)	Backlight ground
3	GND	Ground
4	VDD	Power
5	R0	Red data bus
6	R1	Red data bus
7	R2	Red data bus
8	R3	Red data bus
9	R4	Red data bus
10	R5	Red data bus
11	R6	Red data bus
12	R7	Red data bus
13	G0	Green data bus

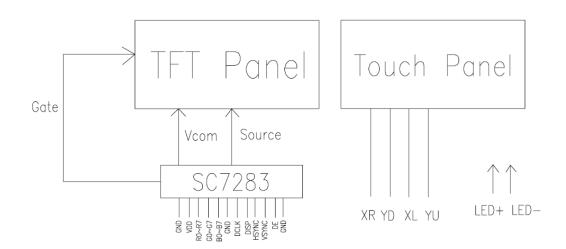




14	G1	Green data bus			
15	G2	Green data bus			
16	G3	Green data bus			
17	G4	Green data bus			
18	G5	Green data bus			
19	G6	Green data bus			
20	G7	Green data bus			
21	B0	Blue data bus			
22	B1	Blue data bus			
23	B2	Blue data bus			
24	В3	Blue data bus			
25	B4	Blue data bus			
26	B5	Blue data bus			
27	B6	Blue data bus			
28	B7	Blue data bus			
29	GND	Ground			
30	DCLK	Dot Pixel Clock			
31	DISP	Display on or off control			
32	HSYNC	Horizontal Sync			
33	VSYNC	Vertical Sync			
34	DE	Data Enable			
35	NC				
36	GND	Ground			
37	XR	TP RIGHT			
38	YD	TP DOWN			
39	XL	TP LEFT			
40	YU	ТР ИР			
40	Ϋ́U	IP UP			

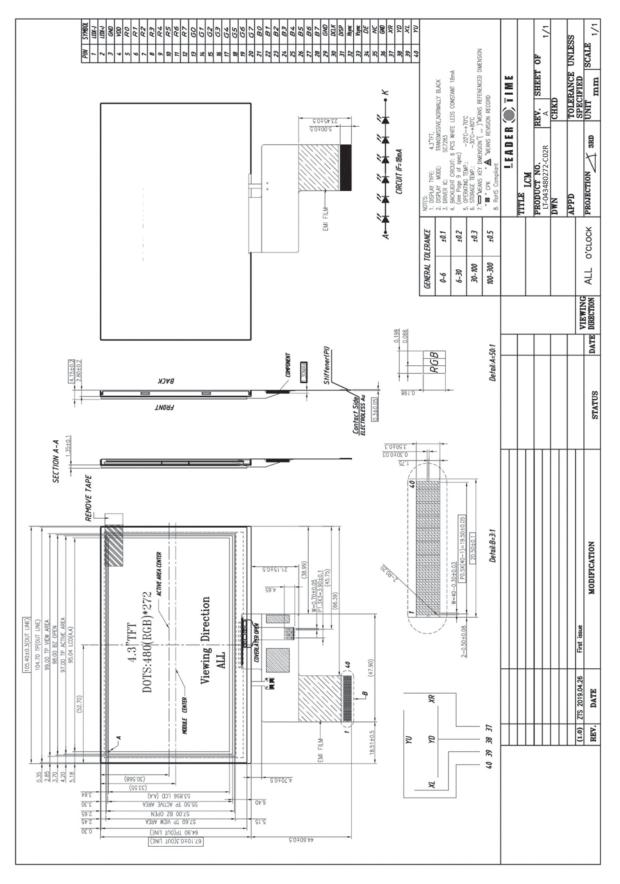


9. Block Diagram of Display



LEADER 💓 TIME

10. Count Drawing





11. Timing Characteristics

Please references SC7283_V1.0 data sheet.

12. Reliability

NO	Item	Test C	Condition		
1	High Temperature Storage	Storage at 70 \pm 2°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs			
2	Low Temperature Storage	Storage at -20 ± 2°C 240 hrs Surrounding temperature, then storag 4hrs	ge at normal condition		
3	High Temperature Operation	Operation at 60 ± 2°C 240 hrs			
4	Low Temperature Operation	Operation at -10 ± 2°C 240 hrs			
5	High Temperature /Humidity Operating	Operation at $60 \pm 2^{\circ}$ C, 90%RH 240 hrs surrounding temperature, then storage at normal condition 4hrs.			
6	Thermal shock (non-operation)	$-20^{\circ}C \rightarrow 25^{\circ}C \rightarrow 70^{\circ}C \rightarrow 25^{\circ}C$ (30mins) (5mins) (30mins) (5mins) $50 Cycle$			
7	Mechanical Test	Freq.: 10-55Hz Max. Acceleration: 5G X.Y.X. each direction For 10 mines. Drop them through 50cm height to strike horizontal plane			
8	ESD Test	Air Discharge: Apply +/-4KV with 5 timesContact Discharge: Apply +/-2KV with 5 timesDischarge for each polarity +/- 1. Temperature ambiance: 15°C~35°CDischarge for each polarity +/- Discharge for each polarity +/-1. Temperature ambiance: 15°C~35°CDischarge for each polarity +/- Discharge Capacitance(Cs+Cd): 150pF+/-10%3. Energy Storage Capacitance(Cs+Cd): 150pF+/-10%Discharge Resistance(Rd): 330Ω+/-10%5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: +/-5%)			

Note 1. For humidity test, DI water should be used

Inspection Standard: Inspect after 1-2hrs storage at room temperature, the sample shall be free from the following defects:

Air bubble in the LCD Seal Leakage Non-display Missing Segment Glass Crack IDD is greater than twice initial value Others as per QA Inspection Criteria

Note 2. No defect is allowed after testing.

Note 3. ESD should be applied to LCD glass panel, not other areas (such as on IC and so on)



IDD should be within twice initial value.

In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

Note 4. Only upon request.

13. Specification of Quality Assurance

13.1 Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer by Casil.

13.2 Standard for Quality Test

Casil performs the following tests to ensure the quality of product before shipment.

Sampling Plan:

GB/T2828.1-2003. Single sampling, Normal Inspection Level ☑.

Single sampling, normal inspection

Sampling Level:

Minor Defect: AQL 0.65%

Major Defect: AQL 0.15%.

Reliability Test:

Detailed requirement refer to Reliability Test Specification.

Nonconforming Analysis & Disposition

Nonconforming analysis

Customer should provide overall information of non-conforming sample for their complaints. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

If Casil can not finish the analysis on time, customer will be notified with the progress status. Disposition of nonconforming:

Non-conforming product over ppm level will be replaced.

The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

Agreement Items

Casil and customer shall negotiate if the following situation occurs

There is any discrepancy in standard of quality assurance.

Additional requirement to be added in product specification.

Any other special problem.

13.3 Standard of the Product Visual Inspection

Appearance inspection

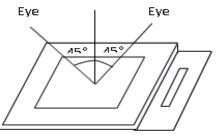
The normal inspection must be under illumination no less than 800lux, and the distance of view must be between 30cm and 45cm;



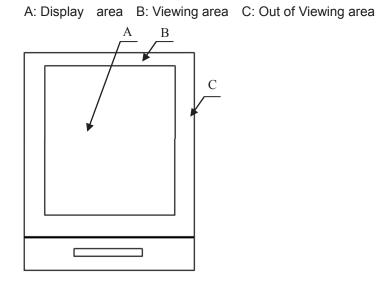


When inspect the model of transmissive product, back light must be lighted.

The visual viewing angle should be 45° from the vertical line without reflection shine or follows customer's viewing angle specifications.



Definition of area(refer to product drawing)



Basic principle:

According to IPC standards if standard is not described in specification.

A set of sample to indicate the limit of acceptable quality level must be discussed by both Casil and customer when there is any dispute happened.

New item must be added on time when it is necessary.



13.4 Inspection Specification

No.	Item Criteria (Unit: mm)					
Functi	onal		·			
01	LC leakage	LC leakage	Reject	Maj		
02	Non-display	Non-display	Reject	Мај		
03	Missing segment/ Missing character, dot or icon.	OK NG	Reject	Maj		
04	Exceeded dot/line/segment /Distortion	OK NG	Reject	Мај		
05	Dim Display	part of figures display dim than normal obviously	As the samples confirmed each other	Min		
06	Wrong view angle	View angle is different from spec.	Reject	Maj		
07	Not light	1.Backlight not work 2. Some LED not light	Reject	Maj		
08	Backlight Luminance \ uniformity	According to the product specification or limited samples	Reject	Min		
09	Backlight Color	According to the product specification or limited samples	Reject	Min		
10	Connection failure	FPC gold finger damage	Reject	Maj		
Cosmetic						

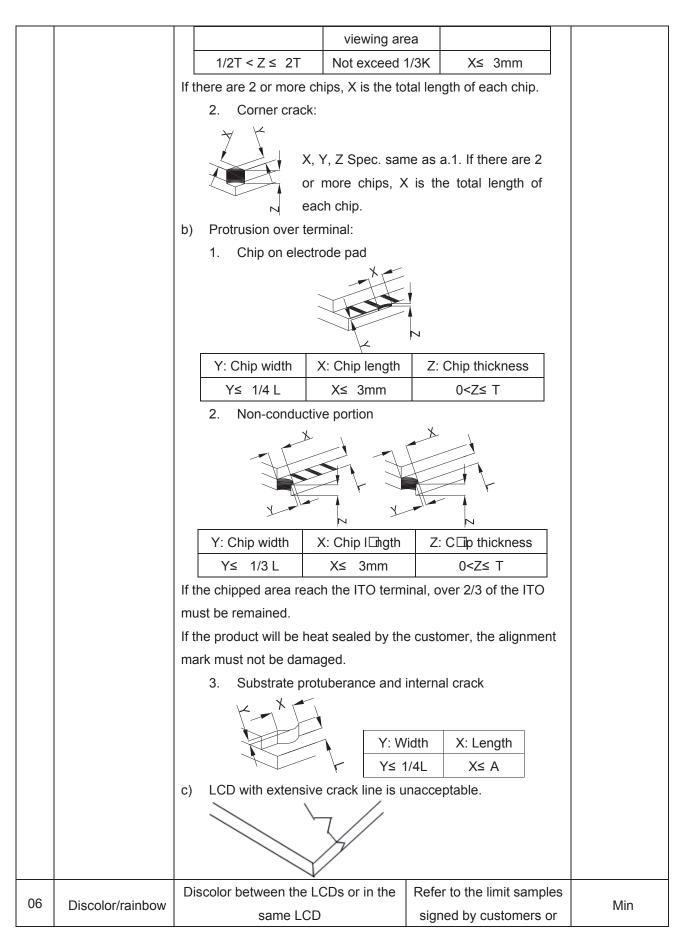


			~					
				Area	1	Acc. (Qty	
	Black and white	Ь	Siz	e(mm)	A	В	С	
	spot, Red, blue			φ ≤ 0.15	lgı	nore	NC	
	and green spot	a	().15<φ ≤ 0.3		2	NC	
01	Dent		().30<φ ≤ 0.5		1	NC	Min
	Foreign material			φ >0.50		0	NC	
	(Round type)	()) (C		Total		3	NC	
	· · · ·	$\phi = (a + b)/2$	L					
		Distance betweer	n 2 defects	s should more t	han 10 i	mm aj	part.	
	Black and White	W						
	line	Length	V	Vidth		Noo ()+\/	
02	Scratch	(mm)				Acc. Qty A B C		Min
	Foreign material	/		≤ 0.03			NC	IVIIII
	(Line type)	L ≤ 5 0.03 ·		≤ 0.03 W ≤ 0.05			NC	
	(Min)			$<$ W \leq 0.00 2 $<$ W \leq 0.1 1			NC	
				W>0.10			NC	
							+	
			TOLAI		3		NC	
		Distance betweer	n 2 defects	s should more t	han 10n	nm ap	oart.	
		Diameter		ļ A	Accept C	Qty		
		Φ (mm)		А		В	С	Min
	Polarizer	Φ <0.2mm		Ignore				
03	concave and	0.2mm<Φ≤ 0.5mm		3	- .			
	convex/bubbles	0.5mm<Φ≤ 0	.7mm	2 ignore		ore	Ignore	
		Φ >0.7mr	n	Unacceptabl				
		Distance between 2 defects should more than 10mm apart.		apart.				
		*A dot is define						
04	Bright/Dark dots,	sub-pixel (either		n, or	Aller			
0-7	lines, Pixel defects	5			Allow		Min	
		that can be seen	through 6	% ND				



		C 11	1	,
		filter.		-
		Bright dots* (Min)	0	
		Adjacent bright dots	0	
		Dark dots*(Min)	2	
		Adjacent dark dots	0	
			Judge by 6% ND filter, check	
		Mura(50% GERY)	with 30cm distance, if still can	
			see, NG	
		Dark or Bright Lines	0	
		Blank pixel/ Missing pixel	Not allow	
		Remark: One pixel consists of 3 s	ub-pixels, including R,G and B	
		dot(Sub-pixel=Dot)		
		Note 1 Bright dot is defined through 6% ti	ransmission ND filter as	
		following:		
		ND Filter - 90° TFT-LCD Panel	Filter TFT-LCD Panel	
		Defects on the black Matrix, out o	f viewing area, aren't	
		considered as a defect counted.		
		Symbols		
		X: Chip length	Y: Chip width	
		Z: Chip thickness	K: Seal width	
		T: Glass thickness	A: LCD side length/LCD	
		L: Electrode pad length		
0.5	TFT Glass	a) General glass chip		
05	cracked	1. Chip on panel surface a	Min	
		Z: Chip thickness Y: Chi	p width X: Chip length	
		Z ≤ 1/2T Not exp	anded in X≤ 1/8A	







			Casil			
07	FPC/FFC /TAB/HSC	Connect surface oxidation	Not allow	Maj		
		Etching/damage /distortion	Not exceed 1/3 width of wire	Min		
		Connect surface contamination /foreign material	Width & length of electric foreign material could not exceed the witdth of 2 pins	Min		
		Connect surface scratch	The scratch depth not exceed 1/2 thickness of gold layer.	Min		
		Copper/protective film/base board film separate	Not allow	Maj		
		Others: FPC follow IPC-6013A standard.				
	Soldering	Cold soldering, short soldering	Reject	Min		
08		Not enough solder paste	Solder paste area < 75% solder pad area Solder paste area < 75% component solder point Solder paste height <1/2 component height	Min		
		FPC Pin deviation	Deviation area > 1/3 Solder pad	Min		
		Others: Follow	IPC-A-610E standard			



09	COG silicon coating	 a) Not exceed the surface of top polarizer, LCD left/right edges. Cover fully ITO, IC and the juncture of HSC/FPC and LCD. b) No visible non-metal foreign material and metal material in coating c) Entrapped air bubble isn' t permissible to exist on the juncture of coating glue and pins of LCD. d) Bubbles or pinhole of silicon coating should Φ ≤ 2mm e) The silicon should cover all around the IC and not gap in between silicon and side of IC, lack of coating on top of IC can be accepted 			
10	Glass warping	Product diagonal length (mm) L≤ 10 10 <l≤ 30<="" td=""> 30<l≤ 100<="" td=""> 100<l≤ 300<="" td=""> 300<l≤ 1000<="" td=""> 1000<l≤ 3000<="" td=""></l≤></l≤></l≤></l≤></l≤>		Warpage range (mm) 0.05 0.1 0.2 0.4 0.6 0.8	Maj
		A Regular shape	Reject B: Newto and not	on ring area> 1/5 TP VA area on ring area < 1/5 VA area affect the display and during operation	Min
11	RTP Newton ring	B Irregular shape	Reject B: Newt and linea Reject C: Newto and not	on ring area> 1/5 TP VA area on ring affect the display writy during operation on ring area < 1/5 VA area affect the display and during operation	Min
12	Backlight	 1.Spots or scratches that appear when light must be judged using LCD glass spot, line and contamination standards. 2.Brightness and Chromaticity can't be out of specification. 			Min



		a) No rust, distortion on the Bezel.b) No visible fingerprints, stains or other contamination.			Min
			1 mm> Ø> 0.5 mm, 2	Accept	Min
		Dent	Ø≤ 0.5 mm	ignore	Min
13	Bezel meta front Expo mate	Exposed base metal material on front surface	Ø≤ 0.5 mm ,2 个	Accept	Min
		Exposed base meta material on side	Dot : Ø≤ 1.0mm, Line: L≤ 2.0mm、 W≤ 0.5mm	Accept	Min
		Scratched	Exposed base metal material	Reject	Min

13.5 RoHS Compliance

The product should RoHS Compliance.



14. Precaution for Using LCD Module

14.1 Handing Precaution

- 14.1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handing especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 14.1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 14.1.3 Do not apply excessive force to the display surface or the adjoining areas since this many cause the color tone to vary. Do not touch the display with bare hands, This will stain the display area and degraded insulation between terminals(some cosmetics are determined to the polarizer)
- 14.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizer with anything harder than an HB pencil lead (glass, tweezers, etc.).Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 14.1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it whit a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents,-Isotropy alcohol or Ethyl alcohol; do not scrub hard to avoid damaging the display surface.
- 14.1.6 Solvents other than those above-mentioned madly damage the polarizer. Especially, do not use the following: water, Ketone, Aromatic solvents. Wipe off saliva or water drops immediately, contact with water over a ling period of time may cause deformation or color fading. Avoid contact with oil and fats.
- 14.1.7 Exerciser care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or current flow in a high-humidity environment.
- 14.1.8 Install the LCD module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 14.1.9 Do not attempt to disassemble or process the LCD module.
- 14.1.10 NC terminal should be open. Do not connect anything.
- 14.1.11 If the logic circuit power is off, do not apply the input signals.
- 14.1.12 Electro-Static Discharge control, since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 14.1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.



14.2 Storage Precaution

- 14.2.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
- 14.2.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0⊠ rad 35⊠, and keep the relative humidity between 40% RH and 60% RH.
- 14.2.3 The polarizer surface should not come in contact with any other objects (we advise you to store them in anti-static electricity container in which they were shipped).
- 14.2.4 During shipment, please handle with care. The packaging bag can not be broken, step on trap. Packaging Carton layer height can not be over two meters.
- 14.2.5 The transportation process should pay attention to the waterproof and moisture-proof measures. Product can not be watering. Ethylene sealed bags can not be unsealed.
- 14.2.6 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 14.2.7 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 14.2.8 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc.,

14.3 Using LCD Modules

- 14.3.1 The hole in the printed circuit board is used to fix LCM. Attend to the following items when installing the LCM. Cover the surface with a transparent protective plate to protect the polarizer and LC cell.
- 14.3.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be +/-0.1mm.
- 14.3.3 Precaution for assemble the module with BTB connector; Please note the position of the male and female connector position.
- 14.3.4 Precaution for soldering the LCM, Manual soldering temperature 300+/-20X time is 3~5S.
- 14.3.5 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 14.3.6 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 14.3.7 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.



14.4 Precautions for Operation

- 14.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 14.4.2 It is an indispensable condition to drive LCD within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD undesirable deterioration, so that the use of direct current drive should be avoid.
- 14.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD show dark color in them. However those phenomena do not mean malfunction or out of order with LCD which will come back in the specified operating temperature.
- 14.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and back on.
- 14.4.5 Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 14.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on.Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive & negative voltage becomes stable.
- 14.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off many occur with high temperature and high humidity.

14.5 Safety

- 14.5.1 It is recommended to crush damaged or unnecessary LCD into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 14.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

14.6 Limited Warranty

- 14.6.1 Unless otherwise agreed between CASIL display and customer, CASIL display will replace or repair any of its LCD and LCM which CASIL display found to be defective electrically and visually when inspected in accordance with CASIL display quality standards, for a period of one year from date of shipment.
- 14.6.2 The warranty liability of CASIL display is limited to repair and/or replacement. CASIL display will not be responsible for any consequential loss.
- 14.6.3 If possible, we suggest you use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.